



APPLICATIONS

- Battery-powered devices
- Portable devices
- Embedded computing
- High-current SMPS
- High-frequency SMPS
- POL converters
- FPGA

FEATURES

- Size 13.5mmx12.6mmx6.2mm
- Molded Construction
- Low Audible Noise
- Soft Saturation
- Stable Over High Temperatures
- Max Operating Temp +155°C
- RoHS/REACH-Compliant, Halogen-Free

ELECTRICAL CHARACTERISTICS

Parameter			Value	Unit
Inductance ⁽¹⁾	L	$\pm 20\%$	1.2	μ H
Resistance	R_{DC}	typ	1.8	m Ω
Resistance _{MAX}	$R_{DC MAX}$	max	2.2	m Ω
Rated Current ⁽²⁾	I_R	typ	24	A
Saturation Current _{25°C} ⁽³⁾	$I_{SAT 25°C}$	typ	37	A
Saturation Current _{100°C} ⁽⁴⁾	$I_{SAT 100°C}$	typ	37	A
Resonance Frequency	f_r	typ	38	MHz

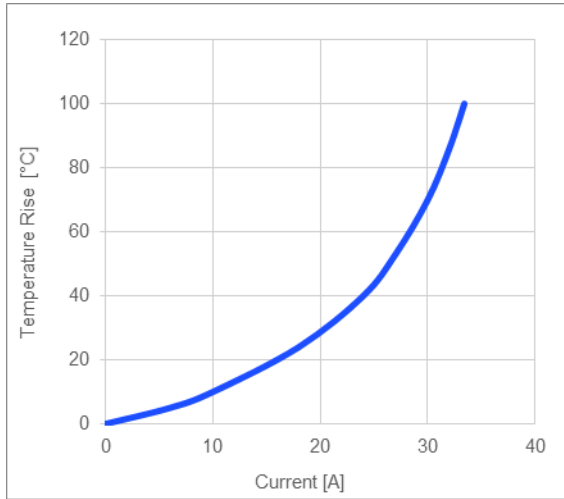
GENERAL SPECIFICATIONS

⁽¹⁾ Inductance	Measured at 100kHz, 100mA
⁽²⁾ Rated Current	Rated current will cause the coil temperature rise ΔT of 40K I_R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35 μ m Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.
⁽³⁾ Saturation Current _{25°C}	Saturation current will cause L to drop from 30% at 25°C ambient temperature
⁽⁴⁾ Saturation Current _{100°C}	Saturation current will cause L to drop from 30% at 100°C ambient temperature
Temperature Test Condition	Electrical specifications measured at 25°C, 35% RH if not given differently
Operating Condition	Operating temperature: -40°C to +155°C (including temp rise) Should not exceed +155°C under worst-case operation conditions
Storage Condition	Tape and Reel packaging: -10°C to +40°C Humidity: <50% RH

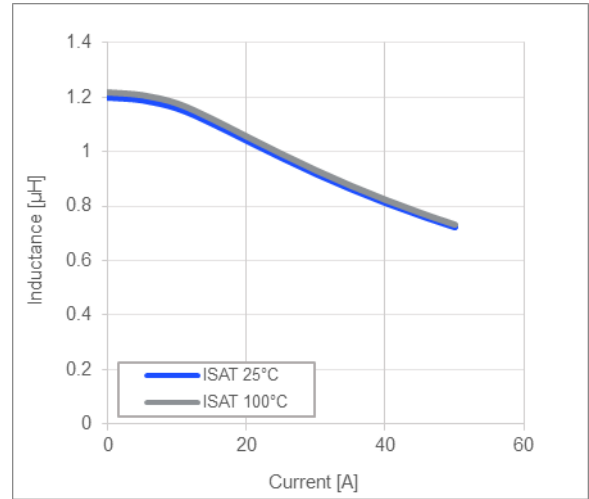
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TYPICAL PERFORMANCE CURVES

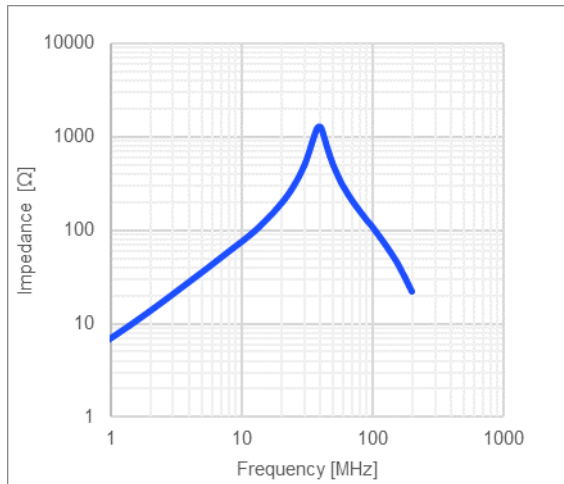
Temperature Rise vs. Current



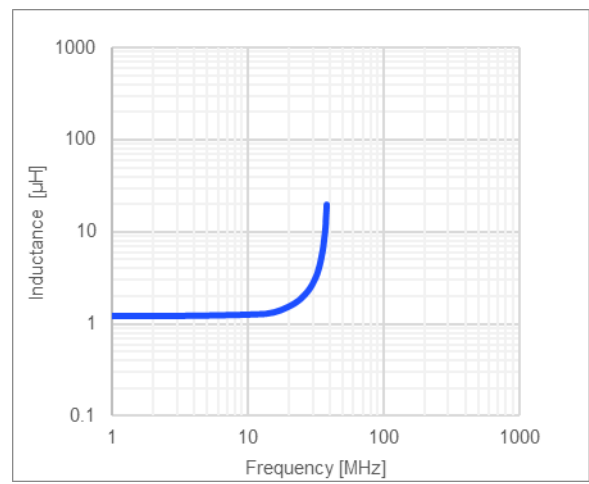
Inductance vs. Current



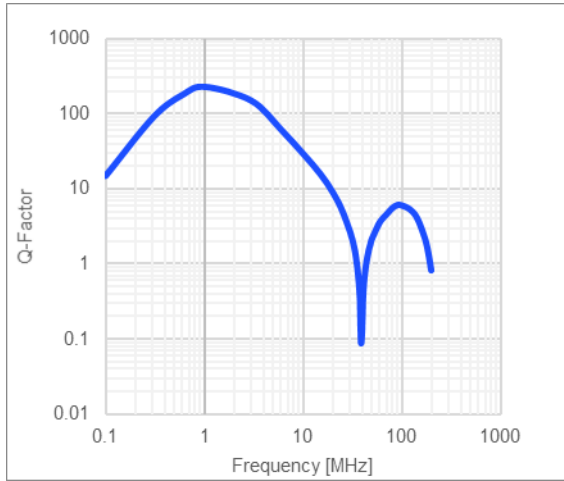
Impedance vs. Frequency



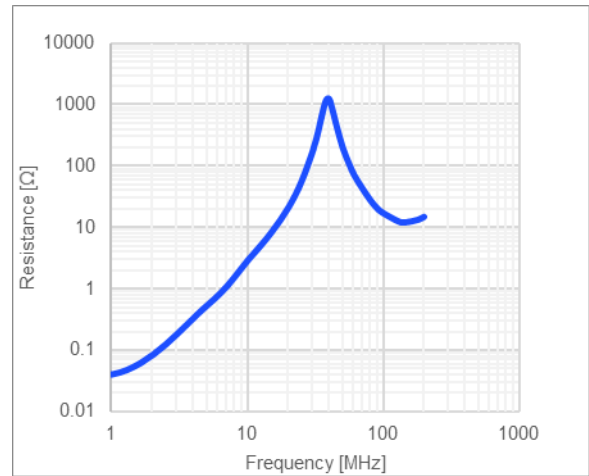
Inductance vs. Frequency



Quality Factor vs. Frequency



AC Resistance vs. Frequency



LAND PATTERN
Dimensions

A	5.0 ref.
B	8.0 ref.
C	14.50 ref.

(unit in mm)


PRODUCT PACKAGE AND DIMENSIONS
Dimensions

(unit in mm)


TOP MARKING
Marking

Start of Winding	· (dot)
Inductance Code	1R2
MPS Code	MPS
Date Code	YYWW

ORDERING INFORMATION

Part Number	$L^{(1)}$	R_{DC}	$I_R^{(2)}$	$I_{SAT\ 25^\circ C}^{(3)}$	$I_{SAT\ 100^\circ C}^{(4)}$
	typ (μH)	typ (mΩ)	typ (A)	typ (A)	typ (A)
MPL-AY1265-R47	0.47	0.89	33	64	64
MPL-AY1265-R56	0.56	1.1	31	58	58
MPL-AY1265-R68	0.68	1.25	29	51	51
MPL-AY1265-R82	0.82	1.3	27	46	46
MPL-AY1265-1R0	1.0	1.5	25.5	43	43
MPL-AY1265-1R2	1.2	1.8	24	37	37
MPL-AY1265-1R5	1.5	2.3	22	34	34
MPL-AY1265-1R8	1.8	3.3	20	29	29
MPL-AY1265-2R2	2.2	3.7	17	26.5	26.5
MPL-AY1265-3R3	3.3	5.5	16	25	25
MPL-AY1265-4R7	4.7	7.0	14	23	23
MPL-AY1265-5R6	5.6	8.6	13	20	20
MPL-AY1265-6R8	6.8	9.9	12	19.5	19.5
MPL-AY1265-8R2	8.2	12.5	11.5	18	18
MPL-AY1265-100	10	13.3	10.7	16	16
MPL-AY1265-150	15	21.8	8.5	12	12
MPL-AY1265-220	22	31.4	7	9	9

GENERAL SPECIFICATIONS

(1) Inductance Measured at 100kHz, 100mA

(2) Rated Current Rated current will cause the coil temperature rise ΔT of 40K
 I_R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35μm Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.

(3) Saturation Current 25°C Saturation current will cause L to drop from 30% at 25°C ambient temperature

(4) Saturation Current 100°C Saturation current will cause L to drop from 30% at 100°C ambient temperature

Temperature Test Condition Electrical specifications measured at 25°C, 35% RH if not given differently

Operating Condition Operating temperature: -40°C to +155°C (including temp rise)
 Should not exceed +155°C under worst-case operation conditions

Storage Condition Tape and Reel packaging: -10°C to +40°C
 Humidity: <50% RH

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